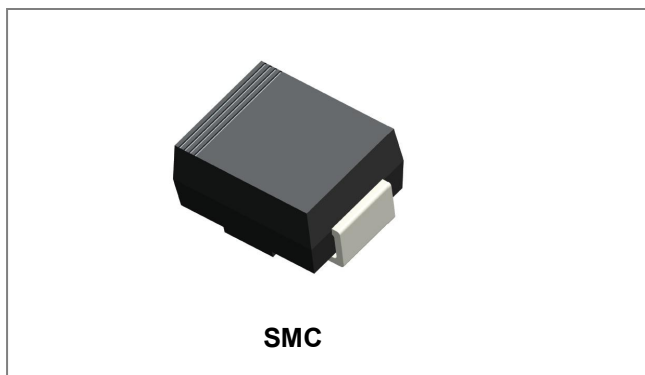


S3A THRU S3M
SURFACE MOUNT GENERAL RECTIFIER
Reverse Voltage - 50 to 1000 Volts Forward Current - 3.0 Amperes



Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Low reverse leakage
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed: 260° C/10 seconds at terminals
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

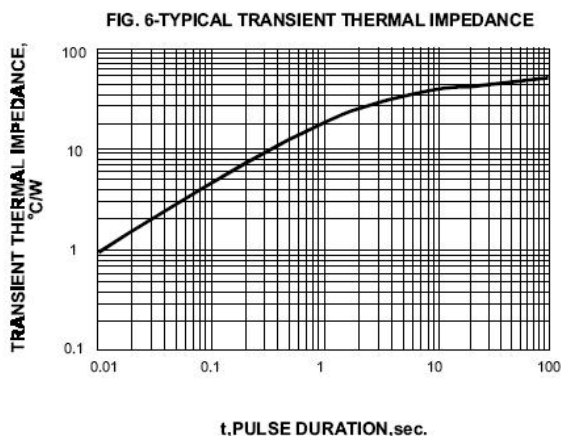
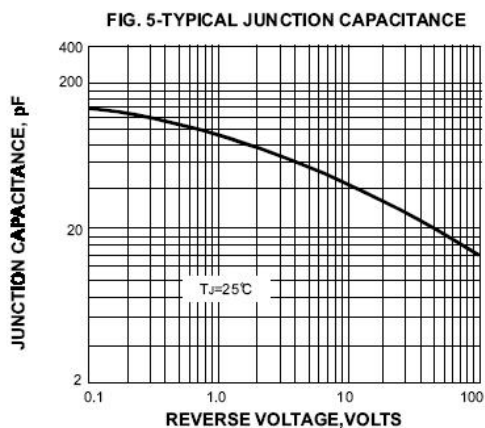
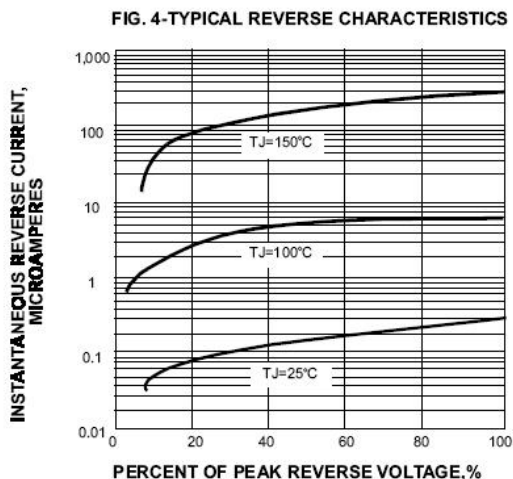
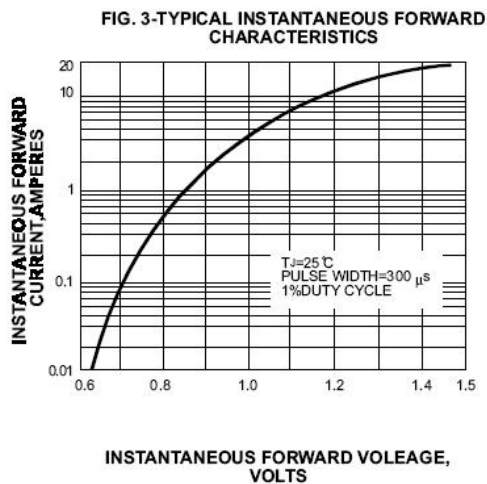
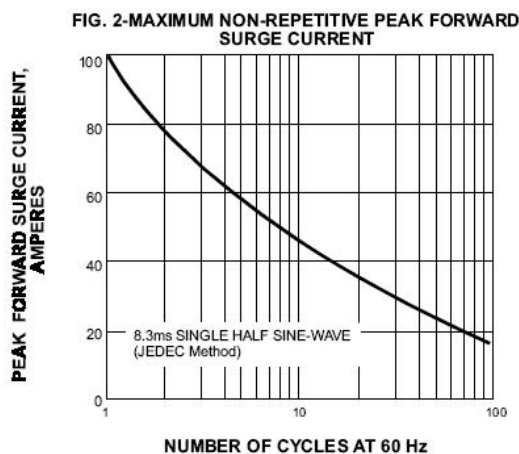
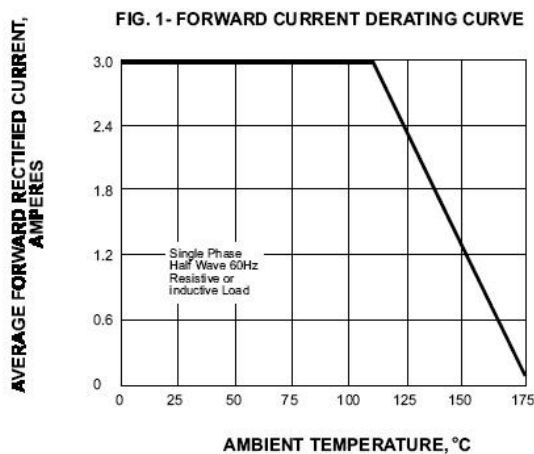
- Case: SMC molded plastic
- Lead: Solder Plated , Solderable Per MIL-STD 750 ,Method 2026
- Polarity: Color band denotes cathode end
- Weight: 0.21 grams

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

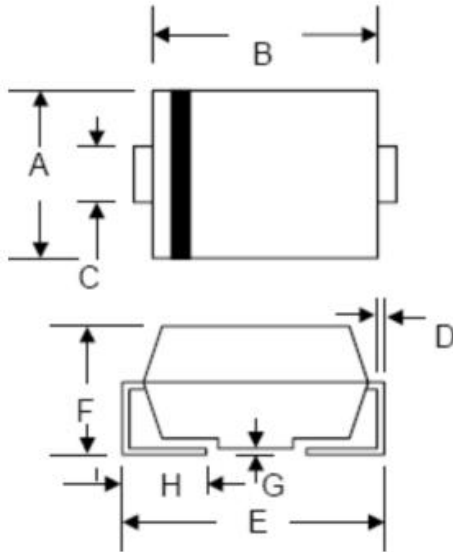
Characteristic	Symbol	S3A	S3B	S3D	S3G	S3J	S3K	S3M	Units
Maximum repetitive peak reverse voltage Maximum DC blocking voltage	V_{RRM} V_{DC}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum average forward rectified current @T _L = 110°C	$I_{(AV)}$	3.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	100.0							A
Maximum instantaneous forward voltage at 3.0A	V_F	1.1							V
Maximum DC reverse current @T _A = 25°C at rated DC blocking voltage @T _A = 100°C	I_R	5.0 100.0							μA
Typical Junction Capacitance (Note 1)	C_J	60.0							pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	50.0							°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175							°C

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas.

Ratings and Characteristics Curves



Mechanical Dimensions SMC



SYMBOL	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	5.59	6.22	0.220	0.245
B	6.60	7.11	0.260	0.280
C	2.90	3.20	0.114	0.126
D	0.152	0.305	0.006	0.012
E	7.75	8.13	0.305	0.320
F	2.00	2.62	0.079	0.103
G	-	0.203	-	0.008
H	0.76	1.52	0.030	0.060

Ordering Information

Device	Package	Shipping
S3A-S3M	SMC (Pb-Free)	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram

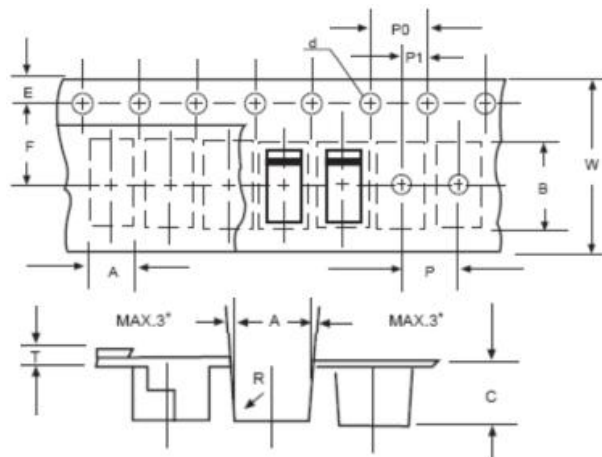


Where XXXXX is YYWWL

S3A = Part Name
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Carrier Tape Specification SMC



SYMBOL	Millimeters	
	Min.	Max.
A	5.90	6.10
B	8.20	8.40
C	2.40	2.60
d	1.40	1.60
E	1.40	1.60
F	7.60	7.70
P	7.90	8.10
P0	3.90	4.10
P1	3.90	4.10
T	-	0.600
W	15.80	16.20

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